

/ Descriptions

SOT-23

Silicon Diode in a SOT-23 Plastic Package.

/ Features

AEC-Q101

Small signal diode, Qualified to AEC-Q101 Standards for High Reliability, HF Product.

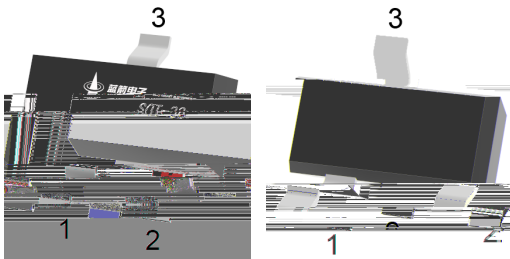
/ Applications

High Conductance Ultra Fast Diode, Meet the stringent requirements of automotive applications.

/ Equivalent Circuit



/ Pinning



PIN: See Equivalent Circuit.

/ Marking

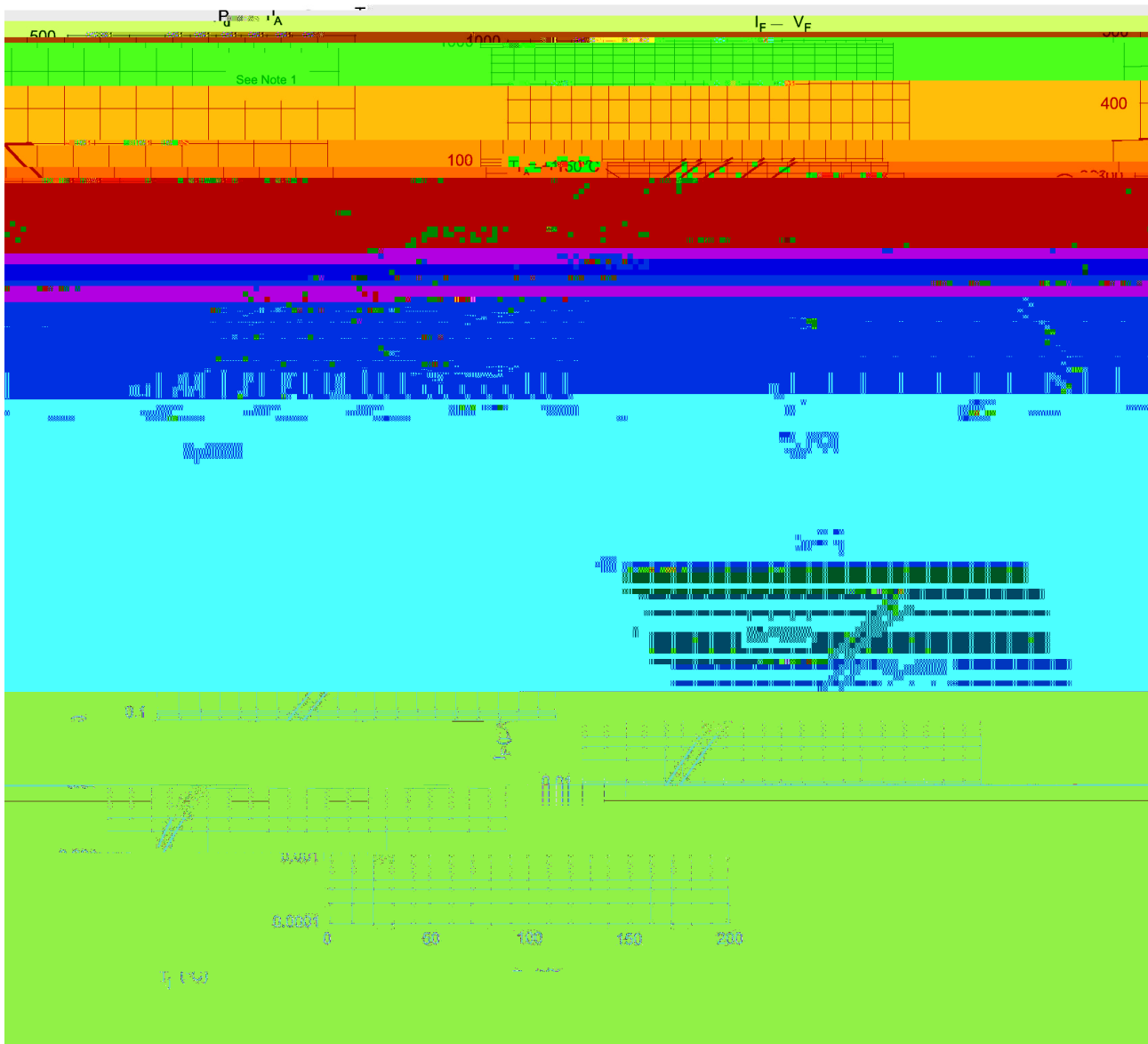
Marking	QA4
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Parameter	Symbol	Rating	Unit
Maximum Repetitive Reverse Voltage	V_{RRM}	75	V
Breakdown Voltage	V_R	70	V
Average Rectified Forward Current	$I_{F(AV)}$	200	mA
Non-repetitive Peak Forward Surge Current	$I_{FSM(1)}$ (pulse width=1.0S)	1.0	A
	$I_{FSM(2)}$ (pulse width=1.0mS)	2.0	A
Power Dissipation	P_D	350	mW
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	357	/W
Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55 150	

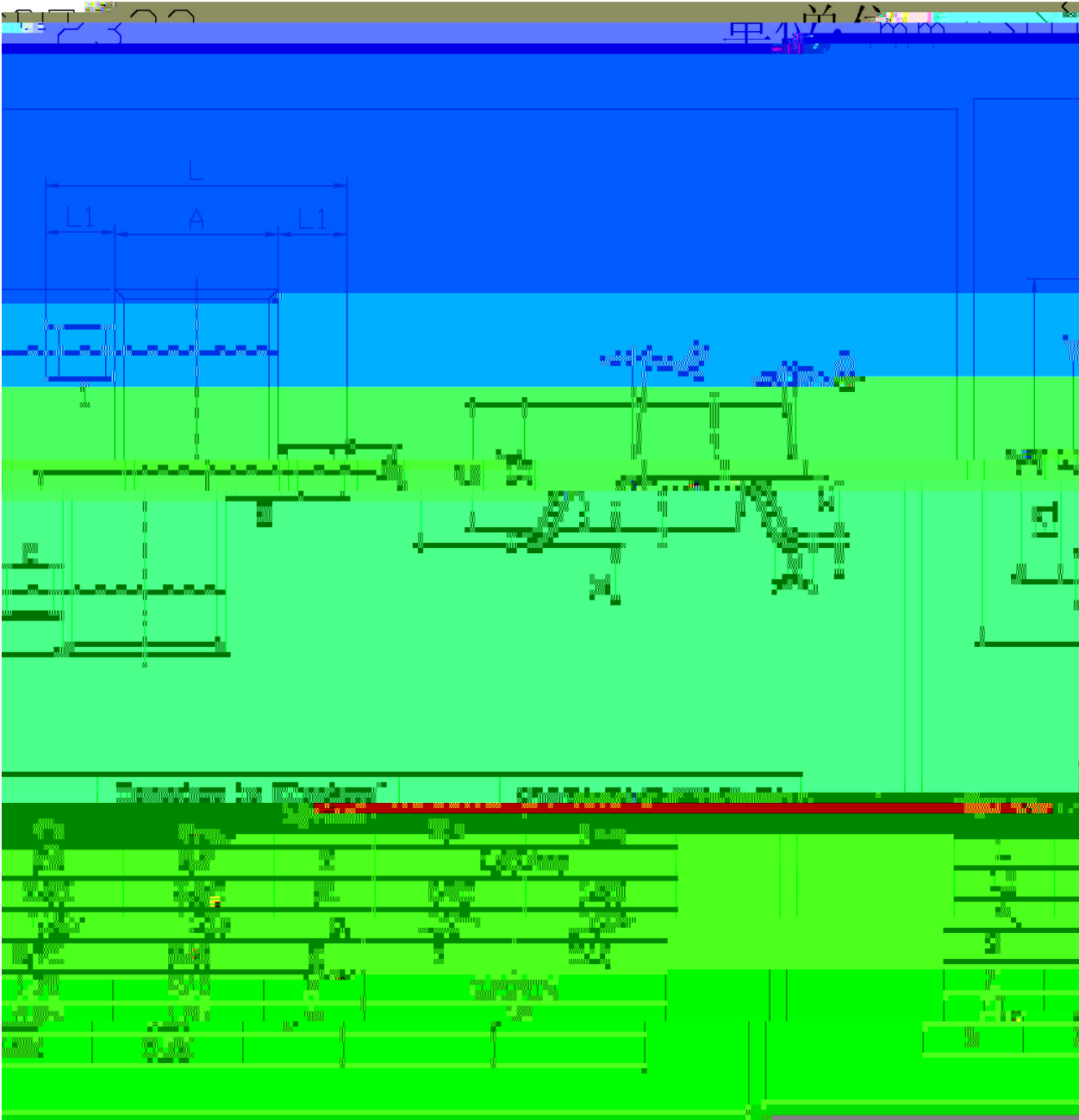
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Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Breakdown Voltage	V_R	$I_R=100\mu A$	70			V
Forward Voltage	V_F	$I_F=1.0mA$			715	mV
		$I_F=10mA$			855	mV

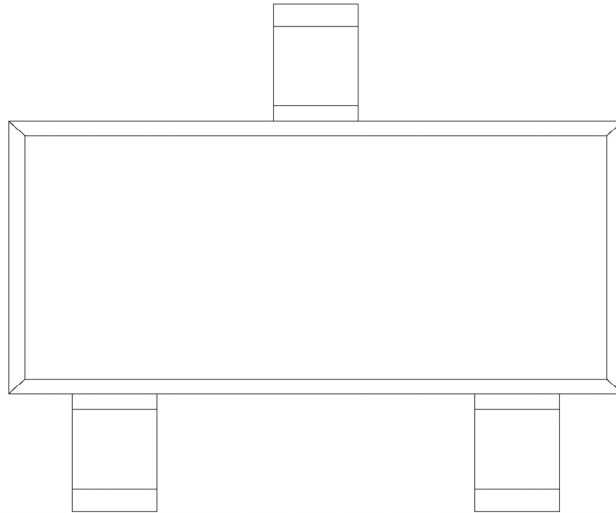
/ Electrical Characteristic Curve



/ Package Dimensions

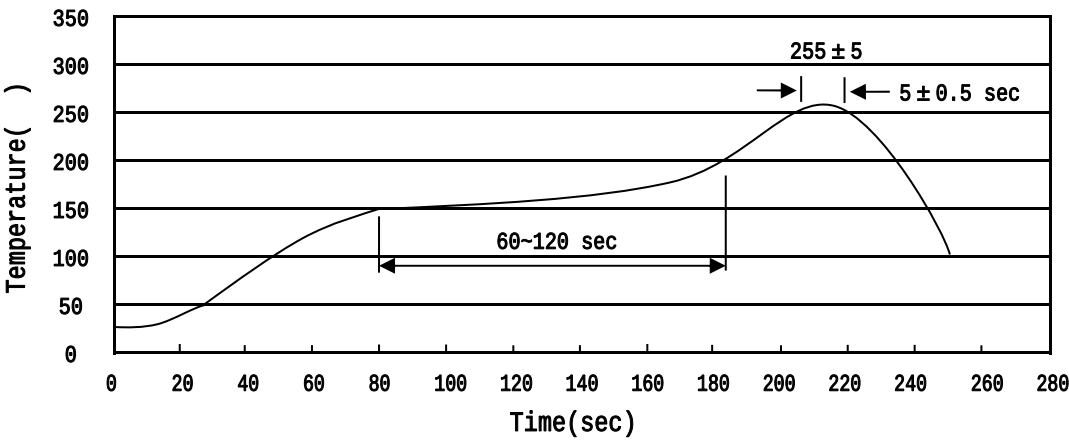


/ Marking Instructions



Q
A4

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

- 1

150 200

60 120sec;

1.Preheating:150~200 , Time:60~120sec.
- 2

255±5

5±0.5sec;

2.Peak Temp.:255±5 , Duration:5±0.5sec.
- 3

2 10 /sec.

3.Cooling Speed: 2~10 /sec.

/ Resistance to Soldering Heat Test Conditions

260±5 10±1 sec. Temp.:260±5 Time:10±1 sec

/ Packaging SPEC.

/ REEL

Package Type	Units					Dimension (unit mm ³)		
SOT-23	3,000	10	30,000	6	180000	7 ×8	180×120×180	390×385×205

/ Notices